



### **6.0A GLASS PASSIVATED BRIDGE RECTIFIER**

Reverse Voltage - 100 to 1000 V

Forward Current - 6.0A

#### **FEATURES**

♦Surge overload rating - 125 amperes peak

♦Ideal for printed circuit board

♦Glass Passivated Chip Junction

♦Mounting position: Any

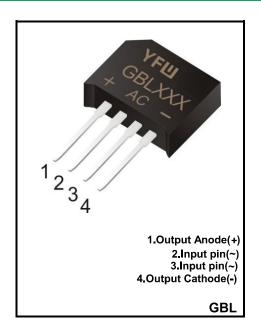
♦Lead free in comply with EU RoHS 2011/65/EU directives

#### **MECHANICAL DATA**

♦Case: GBL

♦Terminals: Solderable per MIL-STD-202, Method 208

♦Approx. Weight: 2.15g / 0.076oz



### **Maximum Ratings and Electrical characteristics**

Ratings at 25 °C ambient temperature unless otherwise specified.

Parameter	Symbols	GBL601	GBL602	GBL604	GBL606	GBL608	GBL610	Units
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	100	200	400	600	800	1000	v
Maximum RMS voltage	V <sub>RMS</sub>	70	140	280	420	560	700	v
Maximum DC Blocking Voltage	V <sub>DC</sub>	100	200	400	600	800	1000	v
Maximum Average Forward (with heatsink Note2) Rectified Current @ Tc=100°C(without heatsink)	I <sub>(AV)</sub>	6.0 2.6					А	
Peak Forward Surge Current 8.3 ms Single Half Sine-Wave Superimposed on Rated Load (JEDEC method)	I <sub>FSM</sub>	175					Α	
Forward Voltage Voltage @6.0ADC Drop per element @3.0ADV	V <sub>F</sub>	1.1 1.0					v	
Maximum DC Forward Voltage @Tj=25℃ At rated DC blocking voltage @Tj=125℃	I <sub>R</sub>	5.0 500.0					μΑ	
T <sup>2</sup> t Rating for Fusing (t< 8.3ms)	l <sup>2</sup> t	127				A <sup>2</sup> S		
Typical Junction Capacitance (Note 1)	CJ	55				pF		
Typical Thermal Resistance (Note 2)	R <sub>(JC)</sub>	4.2				°C/W		
Operating Temperature Range	TJ	-55 ~ +150				°C		
Storage Temperature Range	T <sub>stg</sub>	-55 ~ +150			°C			

<sup>(1).</sup> Measured at 1.0 MHz and applied reverse voltage of 4.0Vdc

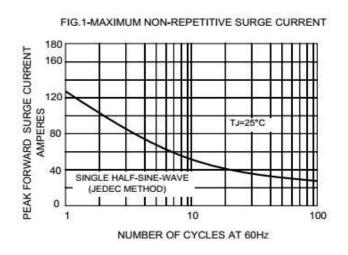
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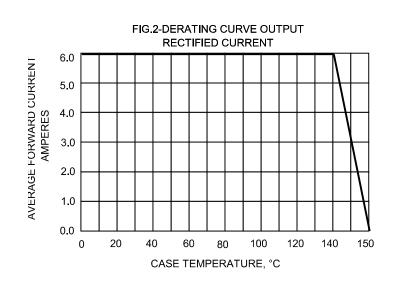
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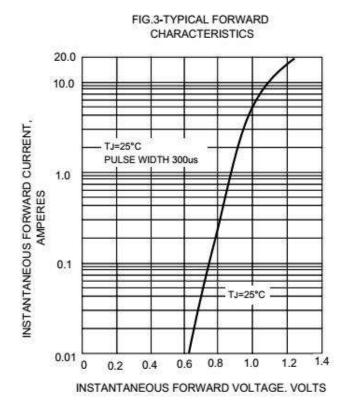
<sup>(2).</sup> Device mounted on 75mm x 75mm x 1.6mm Cu Plate Heatsink.

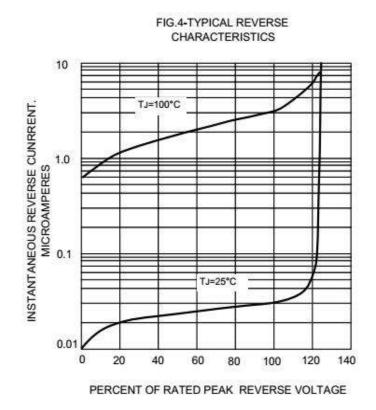


### **Ratings And Characteristic Curves**





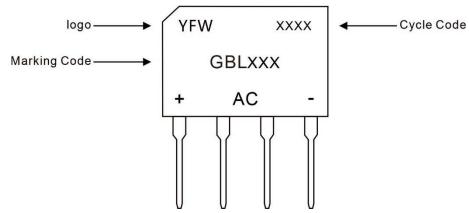




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## **Marking Diagram**

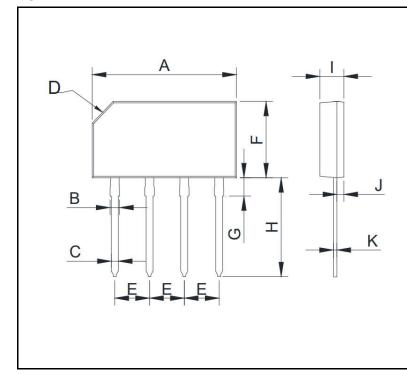


# **Ordering information**

Package Packing Description		Packing Quantity		
GBL	bulk	500PCS/Box 5000PCS/Carton		

# **Package Dimensions**

### **GBL**



Dim.	Millimet	ter(mm)	Dimensions inInch		
Dilli.	Min. Max.		Min.	Max.	
Α	19.2	21.2	0.756	0.835	
В	1.2	1.8	0.0472	0.0709	
С	1.0	1.2	0.0394	0.0472	
D	Typ:3.0		Тур:0.118		
E	4.9	5.1	0.193	0.201	
F	10.5	11.5	0.413	0.453	
G	2.0	3.0	0.079	0.118	
Н	13.0	15.0	0.512	0.591	
I	3.0	4.0	0.118	0.157	
J	0.9	1.1	0.035	0.043	
K	0.4	0.6	0.016	0.024	

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